R-IN32M3 Series

EoE Web server function edition

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Introduction

This document explains a sample program for adding Web server function using EoE service in the EtherCAT® Slave Stack Code (SSC) environment provided by EtherCAT Technology Group of R-IN32M3-EC.

Target Device

R-IN32M3-EC

Contents

1. Overview

This document explains a sample program for adding Web server function by EoE (Ethernet over EtherCAT) service to EtherCAT slave device.

EtherCAT communication program is created with the EtherCAT Slave Stack Code generation tool (SSC Tool) provided by Beckhoff Automation. This sample program provides the SSC Tool project file for using the EoE service, the ESI file, and the patch file for making corrections for this sample program.

Ethernet communication program for EoE uses the Renesas Electronics TCP/IP protocol official version stack (TCP/IP stack) for R-IN32M3, and this provides a virtual Ethernet driver for the connection between the EoE service and the TCP/IP stack.

Table 1.1. Requirements

Item	Description
Board	TS-R-IN32M3-EC Board TS-R-IN32M3-CEC Board R-IN32M3-EC Board Lite
CPU	R-IN32M3-EC
IDE	IAR Systems Embedded Workbench® for Arm Version 8.20.2 or later
Emulator	IAR Systems I-jet
SSC Tool	EtherCAT Technology Group Beckhoff Automation Slave Stack Code Tool Version 5.12
Software PLC	Beckhoff Automation TwinCAT®3
TCP/IP stack	TCP / IP stack for the Renesas Electronics R-IN32

The main functions of the TCP/IP stack for R-IN32 are shown below.

- Supports IPv4, ARP, ICMP, IGMPv2, UDP, TCP protocol

- DHCP client, DNS client, FTP server, HTTP server function available

For detailed specifications of the TCP/IP stack for R-IN32, refer to the following user's manual.
R-IN32 Series User's Manual TCP/IP Stack Edition (R18UZ0061EJxxxx)

2. Software description

2.1 Software structure

Figure 2.1 shows the software structure of the sample program. The sample program consists of the EtherCAT slave stack part and the TCP/IP stack part.
EoE enables Ethernet-based services and protocols to be used by encapsulating Ethernet communication frames in EtherCAT communication data. The fragmentation of the Ethernet communication frame during assembly and transmission of the segmented Ethernet communication frame at the time of reception due to the encapsulation of the communication data is implemented as the EoE service of the SSC. The virtual Ethernet driver replaces the Ethernet driver on the physical layer of the normal TCP/IP stack and is responsible for passing the Ethernet communication frame between the TCP/IP protocol stack and the EoE service.The HTTP server, which is a network application, sends the contents of the slave to the HTTP client (web browser).

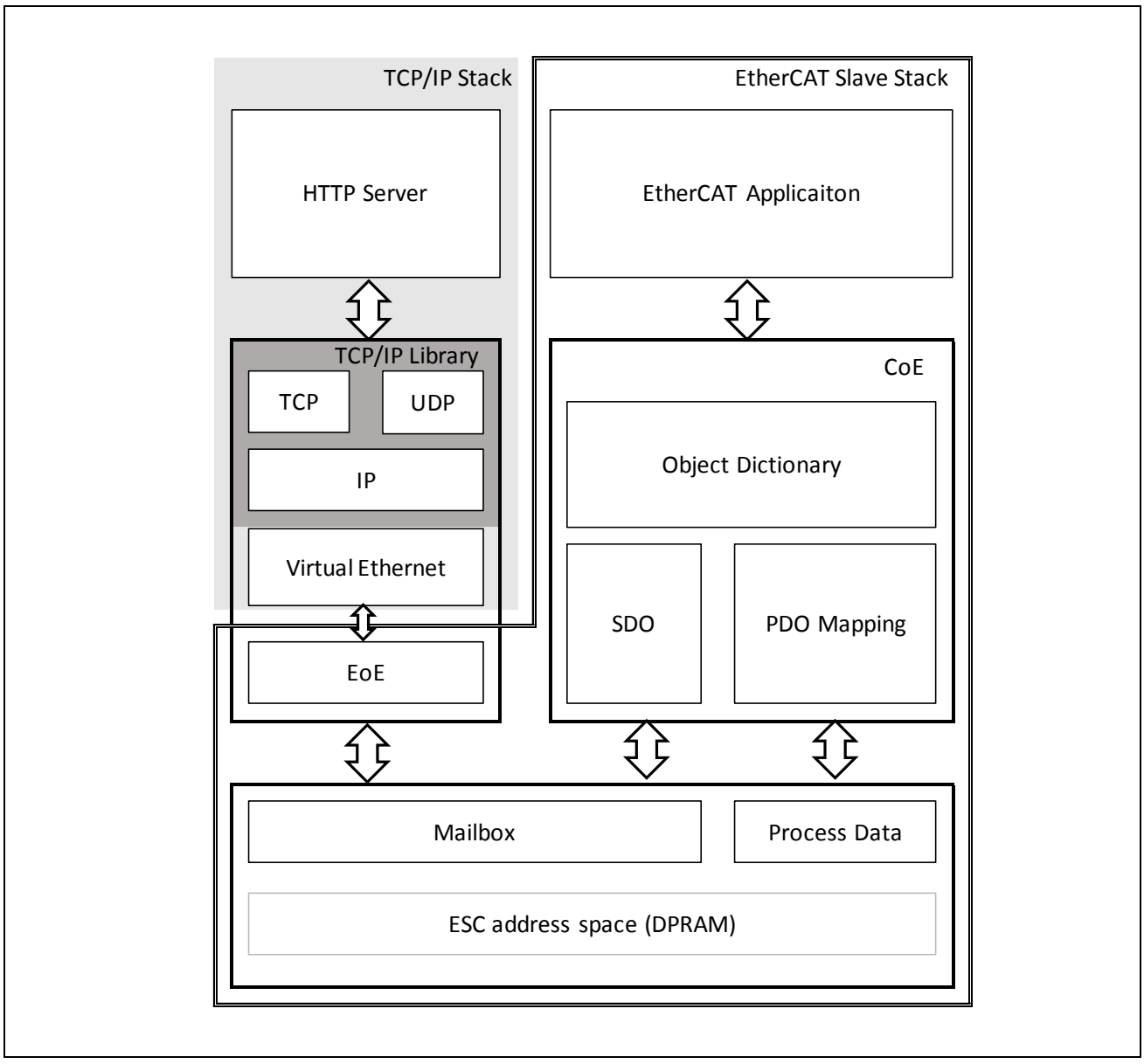

Figure 2.1: Software configuration diagram

2.2 Directory structure

Table 2.1 describes the directories under Device/Renesas/RIN32M3.

Table 2.1. Directory structure of sample program

Item	Description
/Include	Include file store directory
/Include/ecat_unet3	Virtual Ethernet driver header file store directory
/Library	Library store directory
/Library/IAR	OS Library, TCP/IP Library store directory
/Source/Driver	Peripherals driver source file store directory
/Source/Driver/ecat_unet3	Virtual Ethernet driver source file store directory
/Source/Middleware	Middleware source file store directory
/Source/Middleware/uNet3	Ethernet application protocol store directory such as HTTP
/Source/Project/EtherCAT_EoE	EtherCAT EoE sample program store directory
/Source/Project/EtherCAT_EoE/uNet3_sample	Network application store directory
/Source/Templates	Startup file store directory

2.3 List of kernel objects

Table 2.2 shows the software structure of the sample program.

Table 2.2. Sample program kernel object

Object	Object ID	Function
Task	ID_TASK_MAIN	Initialization processing, EtherCAT slave stack task
Task	ID_TASK_TCP_TIM	TCP / IP stack time management task
Task	ID_TASK_ETH_SND	Virtual Ethernet driver transmission task
Task	ID_TASK_HTTPS	HTTP server task
Task	ID_TASK_TCP_APPL	Network application task
Semaphore	ID_SEM_TCP	Protocol stack resource control semaphore
Semaphore	ID_SEM_INTDMA	Virtual Ethernet driver semaphore
Mailbox	ID_MBX_ETH_SND	Virtual Ethernet driver mailbox
Mailbox	ID_MBX_MEMPOL	Memory management mailbox

3. Procedure for creating a sample program

Sample program does not include the source file of the EtherCAT slave stack.

EtherCAT Slave Stack Code Tool (SSC tool) is required to create the source file of the EtherCAT slave stack

Note) Use Ver.5.12 SSC tool.

(1) Double-click the SSC tool project file of the sample program and start the SSC tool.

\Device\Renesas\RIN32M3\Source\Project\EtherCAT_EoE\RenesasSDK\R-IN32M3 EtherCAT EoE.esp

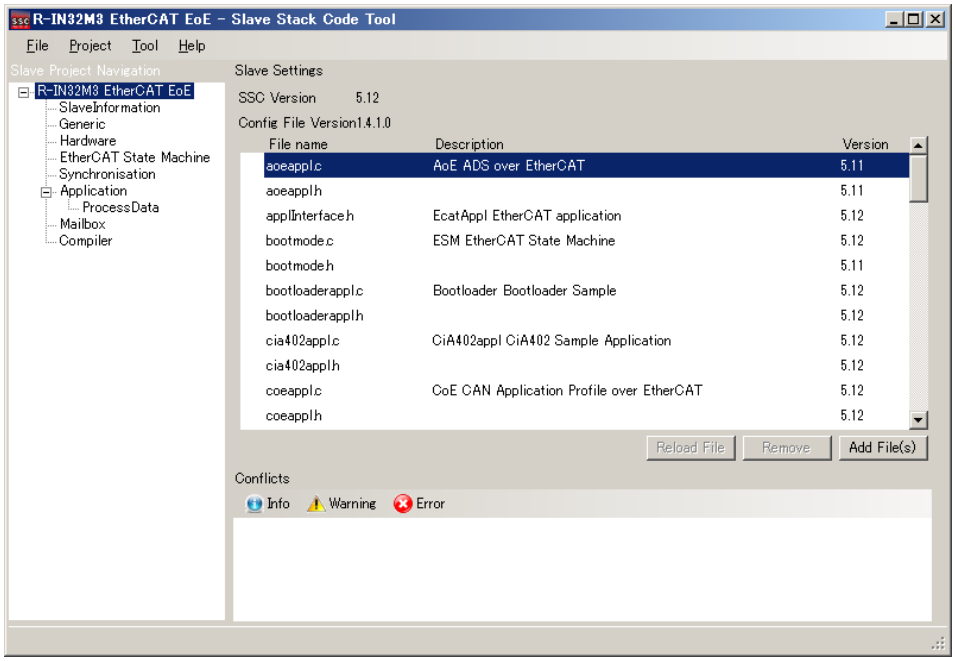

Figure 3.1: SSC Tool startup

(2) Select [Project] ⇒ [Create new Slave Files]

(3) Push Start to generate the EtherCAT Slave Stack Code

(4) Generation is completed when [New files created successfully] is displayed.

\Device\Renesas\RIN32M3\Source\Project\EtherCAT_EoE\RenesasSDK\Src

(5) If patch command is not installed GNU Patch Ver 2.5.9 or later is required.

Download the patch command (Ver 2.5.9) from the following website and store "patch.exe" in the folder passed the directory path.

http://gnuwin32.sourceforge.net/packages/patch.htm

(6) Applying patches,

Right-click on the apply_patch.bat file and select [Run as administrator] ⇒ [Yes].

Patch file contains fixes for R-IN32M3-EC for SSC source files.

\Device\Renesas\RIN32M3\Source\Project\EtherCAT_EoE\RenesaSDK\apply_patch.bat

Figure 3.2: "Apply_patch.bat" execution screen

4. Build and debug the sample program

Double-click the IAR project file and start IAR Embedded Workbench for Arm

\Device\Renesas\RIN32M3\Source\Project\EtherCAT_EoE\IAR\main.eww

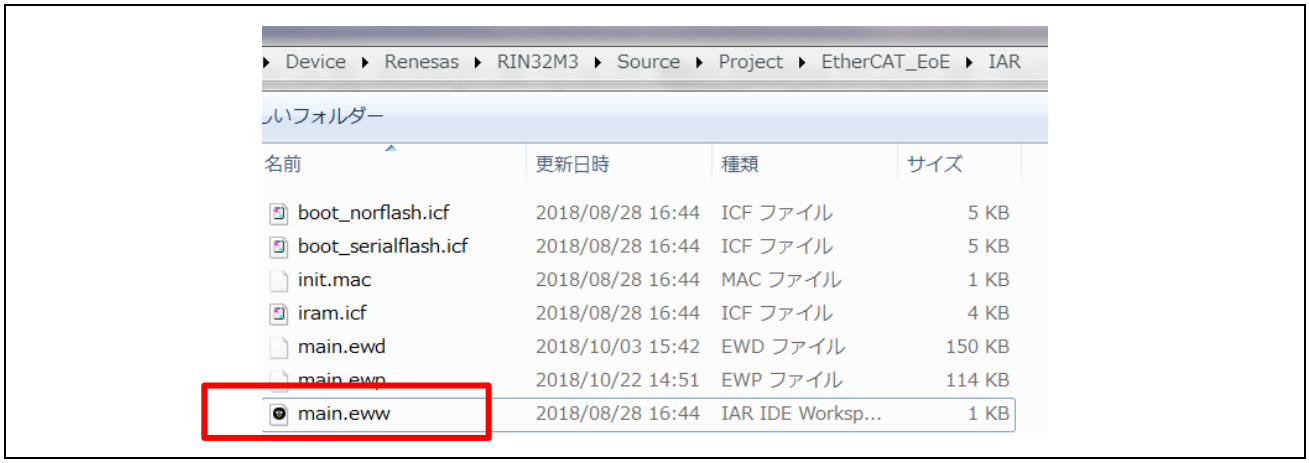

Figure 4.1: IAR project · File directory screen

Table 4.1 shows the build configuration included in the sample program.

Table 4.1. Build configuration of sample program

Build configuration name	Program code download location
RAM Debug	Instruction RAM
Serial Flash Boot	Serial flash ROM
NOR Boot	Parallel flash ROM

(1) Select build configuration

(2) Push "download and debug" button

After the program is built, the program code will be downloaded.

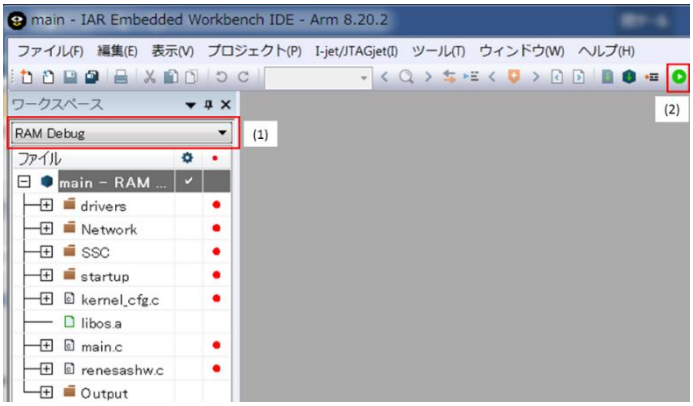

Figure 4.2: EWARM start screen

5. Evaluation board setting

This section explains the board switch settings required for starting the debugger.

1. Boot mode setting

Selection of boot mode of the evaluation board is set by DIP-SW (SW1).

Boot mode selection should be set before connecting the DC adapter.

Table 5.1. Boot mode setting

DIP-SW (SW1)		Boot mode setting
1	2	
ON(High)	ON(High)	Instruction RAM Boot (only debug)
ON(High)	OFF(Low)	Serial flash ROM Boot
OFF(Low)	OFF(Low)	Parallel flash ROM Boot

Note) In TS-R-IN32M3-CEC board and the R-IN32M3-EC Board Lite, for the parallel flash non-mounting, this mode is not supported.

2. EEPROM access

In case of using a board other than the TS-R-IN32M3-EC Board, access to the EEPROM is enabled by default, so this setting is unnecessary.

In order to enable access from Cortex®-M3 to EEPROM with TS-R-IN32M3-EC Board, it is necessary to change J1 switch setting.

Turn off the board power supply and change the J1 switch as follows.

*J1 switch: 1-2: Short, 3-4: Short, 5-6: Opent, 7-8: Open

3. LAN cable connection

Connection of Ethernet cable of the EtherCAT master (PC), please use the port 0 side.

Table 5.2. Evaluation board Ethernet connector

Evaluation board	Port 0 Ethernet connector
TS-R-IN32M3-EC Board	CN6
TS-R-IN32M3-CEC Board	CN6
R-IN32M3-EC Board Lite	CN2 (IN P0)

6. IP address setting

In order to operate the EoE sample program, it is necessary to set the IP address of the EtherCAT master and the EtherCAT slave as fixed IP addresses.

IP address of the EtherCAT slave is set in the network configuration file of the TCP/IP stack of the sample program

\Device\Renesas\RIN32M3\Source\Project\EtherCAT_EoE\uNet3_sample\net_cfg.c

Table 6.1. IP address setting

Setting items	EtherCAT Master	EtherCAT Slave
IPaddress	192.168.1.99(※)	192.168.1.100
Sub-net mask	255.255.255.0	255.255.255.0
Default Gateway	Blank	192.168.1.99(※)

(※) To set the IP address of the EtherCAT master to something other than [192.168.1.99], also set the fault gateway of the EtherCAT slave to the same address.

Figure 6.1 shows the network card settings of the PC used as an EtherCAT master.
Leave the default gateway and DNS server settings blank.

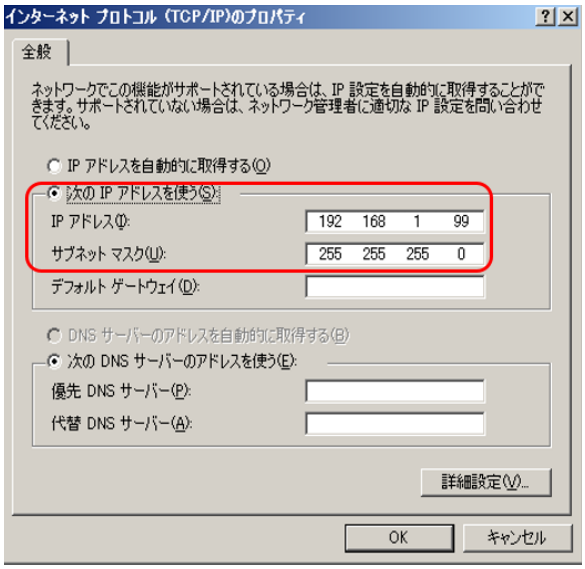

Figure 6.1: EWARM start screen

7. TwinCAT connection procedure

This section describes the procedure for operating the sample program using TwinCAT 3.

Build the source code of the sample program created earlier and start the program.

7.1 Copy ESI file

The ESI file is generated simultaneously when generating the EtherCAT slave stack code with the SSC tool

ESI file generated before launching TwinCAT to the predetermined place of TwinCAT,
copy it to "\TwinCAT\3.x\Config\IO\EtherCAT".

- Copy source (SSC Tool generation ESI file)

  \Device\Renesas\RIN32M3\Source\Project\EtherCAT_EoE\RenesasSDK\ESI_File\ R-IN32M3 EtherCAT EoE.xml

- Copy destination (TwinCAT 3 installation folder)

  \TwinCAT\3.x\Config\IO\EtherCAT

7.2 Connection with TwinCAT

Start up TwinCAT 3 in the following method.

From the start menu, select [Beckhoff] ⇒ [TwinCAT 3] ⇒ [TwinCAT XAE (VS 20 XX)]
After starting the program, create a new project of type TwinCAT XAE Project as [File] ⇒ [New] ⇒ [Project]. The following procedure is described below.

7.2.1 ESI file reload setting

Read the ESI file of the sample program added from TwinCAT.

Select [TwinCAT] ⇒ [EtherCAT Devices] ⇒ [Reload Device Descriptions].

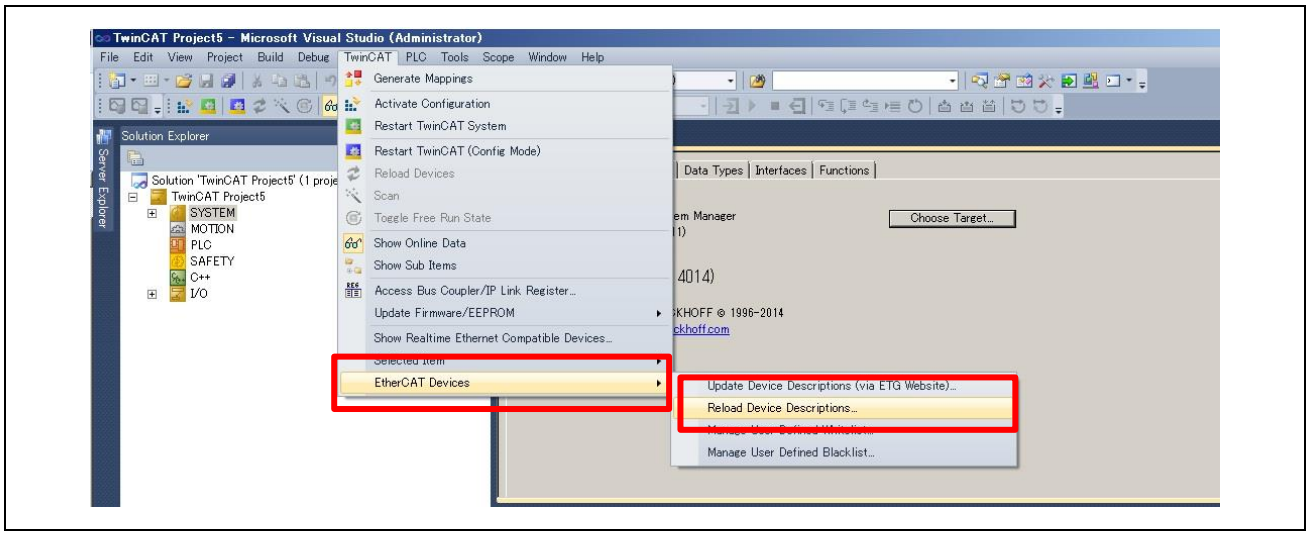

Figure 7.1: ESI file reload

7.2.2 Scanning I/O device

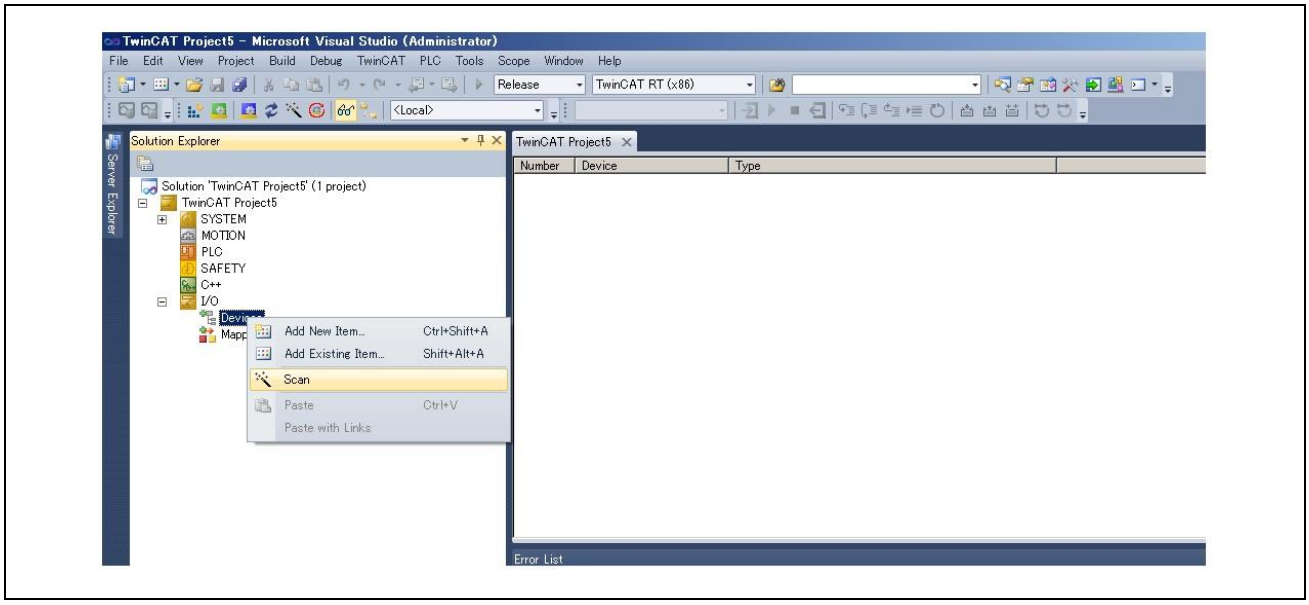

Figure 7.2: Scanning I/O device

Select the above [I / O Device] and right click to open another window. Select [Scan] in this separate window and execute it. For window settings displayed after Scan execution, please select according to Figure 7.3.

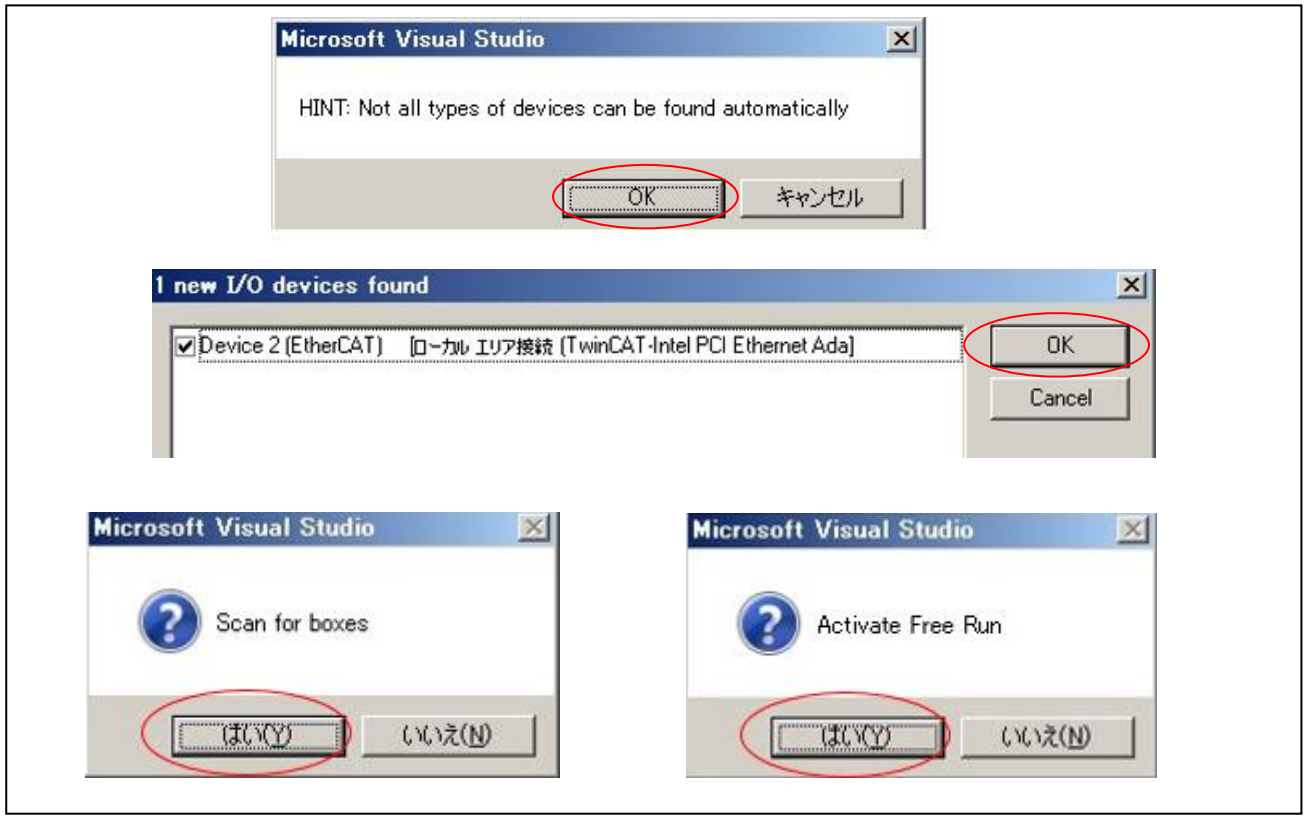

Figure 7.3: I/O Device Scan Settings

7.2.3 EEPROM data update

If data of another application is already written, please rewrite the EEPROM.
The procedure for rewriting the EEPROM is described below.

EEPROM is blank for the first time when purchasing the evaluation board, be sure to rewrite it. In case of blank, [Box 1 (PFFFFFFFF RFFFFFFFF)] is displayed.

(1) Double click on [Box 1], the panel as shown in Figure 7.4 will be displayed.

(2) Select [EtherCAT] tab

(3) Click the [Advanced Setting] button.

(4) Select [ESC Access] ⇒ [EEPROM] ⇒ [Hex Editor]

(5) Select [Download from list].

(6) Select [Available EEPROM Description].

[Renesas Electronics Corp.] ⇒ [R-IN32M3-EC Evaluation Board]⇒[R-IN32M3 EtherCAT EoE]

(7) Click [OK] button.

Restart R-IN32M3 after rewriting (power cycle or reset)

(8) Run [TwinCAT] ⇒ [Restart TwinCAT System] please

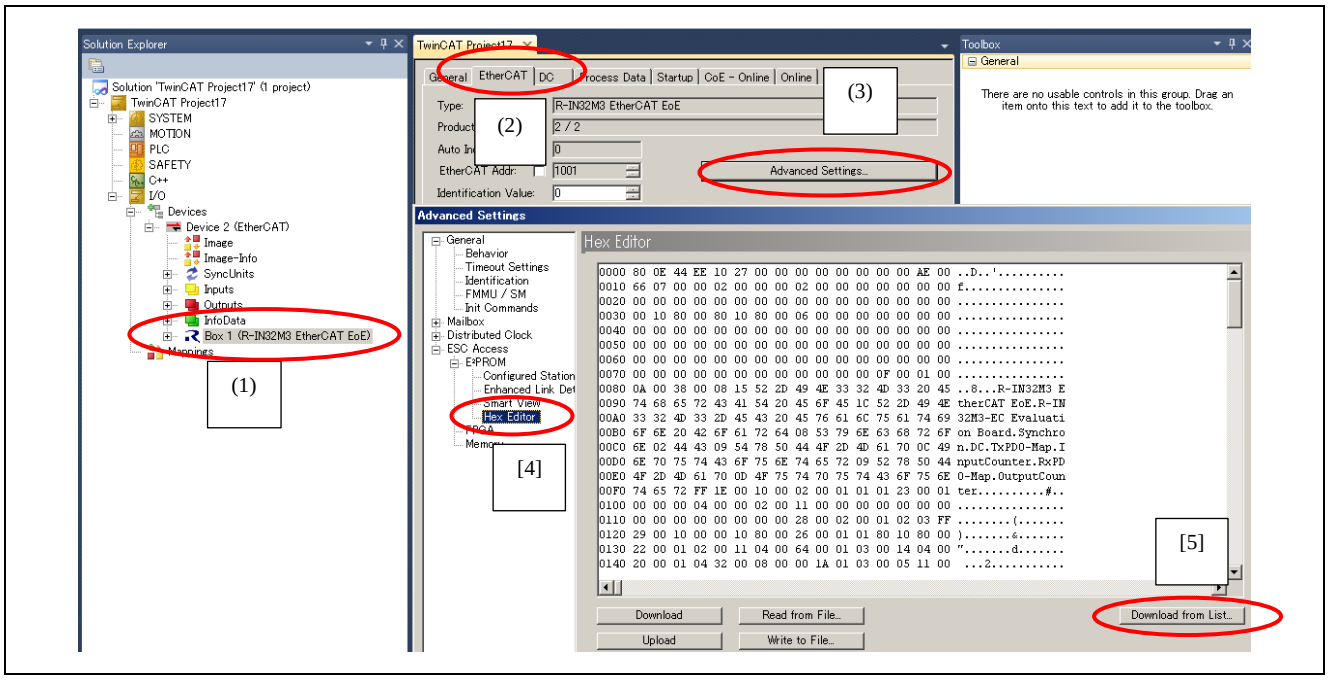

Figure 7.4: EEPROM rewriting procedure 1

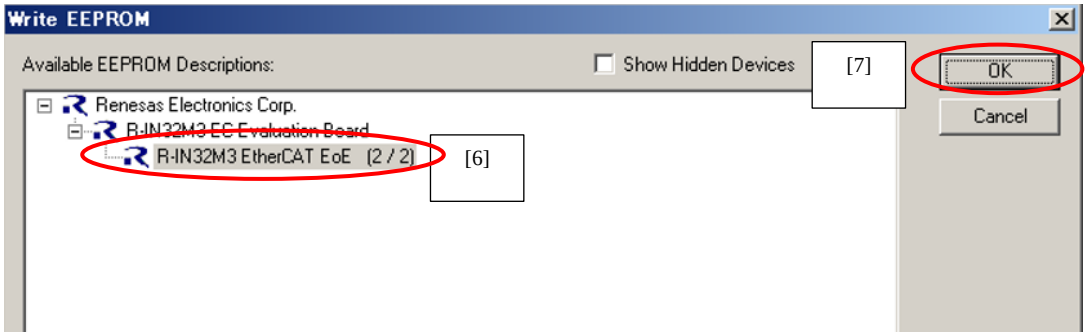

Figure 7.5: EEPROM rewriting procedure 2

7.2.4 Slave EoE settings

(1) Double-click [Box 1] to display the panel.

(2) Select [EtherCAT] tab

(3) Click the [Advanced Setting] button.

(4) Select [Mail box] ⇒ [EoE]

(5) Check [IP Address].

(6) IP Address: [192.168.1.100]
Subnet Mask: [255.255.255.0]
Default Gateway: [192.168.1.99]
input the above

(7) Click [OK] button.

(8) Click the [Restart TwinCAT (Config Mode)] button to activate the EoE setting.

If reset the slave, the EoE setting will return to the initial state (invalid), please save the TwinCAT project file.

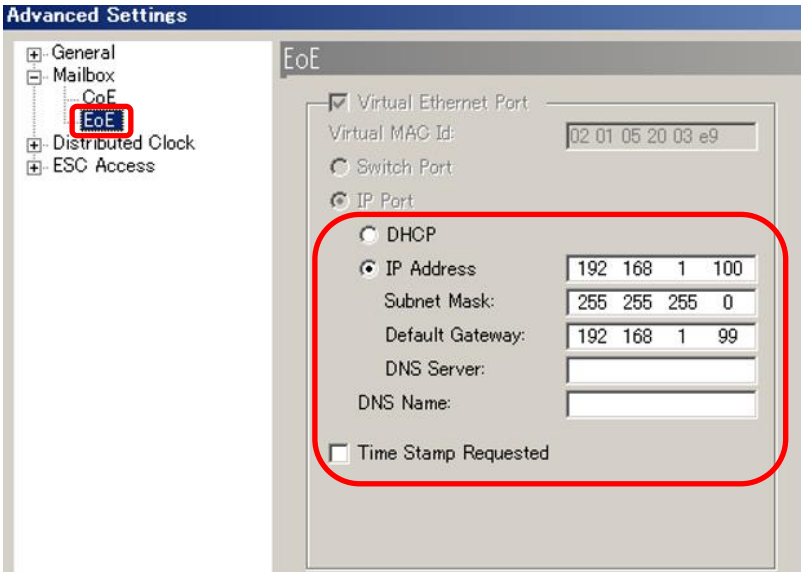

Figure 7.6: Slave EoE setting

8. Confirmation of sample program operation

8.1 EtherCAT

Input Counter is assigned to TxPDO, Output Counter is assigned to RxPDO, Input Counter can confirm the value, Output Counter can change its value.

Output Counter is 0, the value of Input Counter is continuously incremented.

Value other than 0 is set for Output Counter, the Input Counter becomes the value of Output Counter+1.

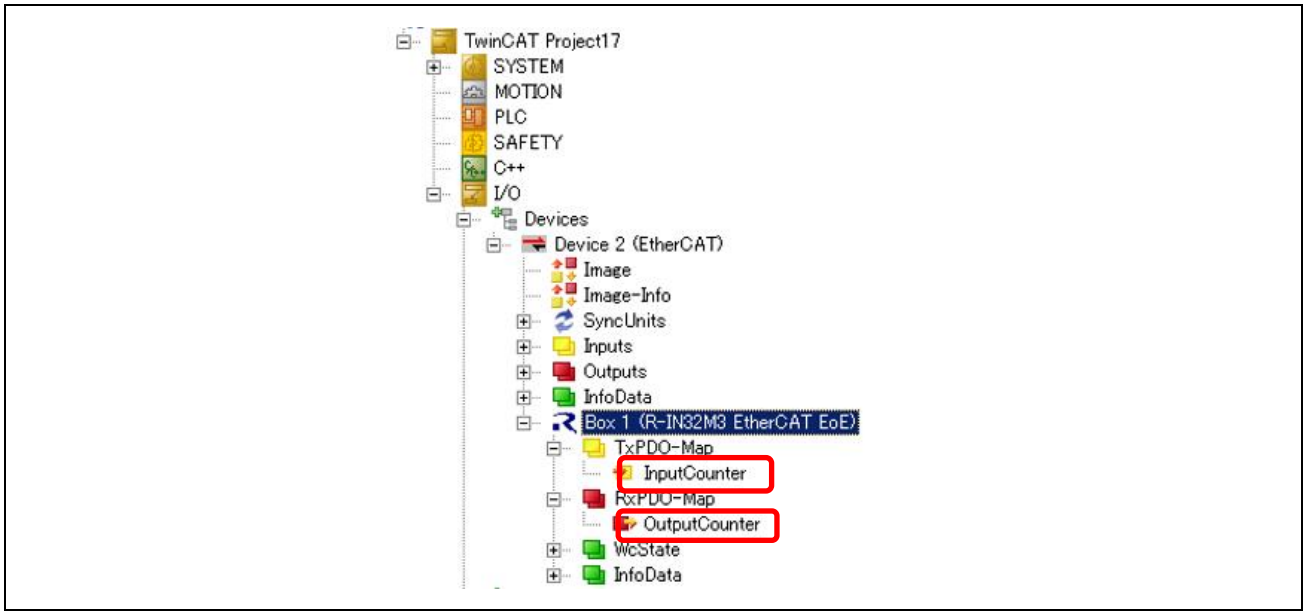

Figure 8.1: TxPDO and RxPDO

8.2 Web Server

(1) Start the Web browser on the PC running the TwinCAT

(2) Set URL field to http: //192.168.1.100

After waiting a while, you can check the web page sent from R-IN32M3 via EoE as shown in Figure 8.2.

Table 8.1 shows the items that can be checked on the Web server and their descriptions.

Table 8.1. Web server operation check item

items	Item Description	Behavior
LED Blinker Interval	Possible to change the blinking interval of LED1 to LED8 of the evaluation board.	After setting the numerical value, pressing the "LED" button will set the blinking interval time to the set value × 100 ms
Ping Request	Request a Ping response for the set IP address	Set the PC's IP address (192.168.1.99) and press the "PING" button. If there is a reply of Ping response, a success message will be displayed
Network Time	It does not work with the connection method with the EtherCAT master described in this application note.	
Resolver		
EtherCAT	Acquire the state of EtherCAT port 0 or 1.	Enter "0" or "1" and press "GET" button. The state of the port when pressed is displayed as shown in figure 8.3

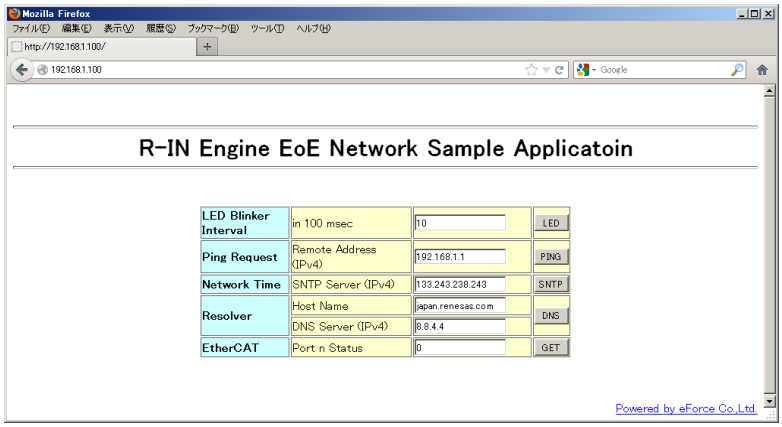

Figure 8.2: Web server screen

Figure 8.3: Web server EtherCAT port status acquisition result

9. Change history

Version	Changes
V1.10 (Jul 10, 2019)	Driver update V1.0.4.
V1.00 (Nov 15, 2018)	First release

10. Website and Support

Renesas Electronics Website
http://www.renesas.com/

Inquiries
http://www.renesas.com/contact/

Revision history

Revision	Date	Page	Changes
1.10	Jul 31, 2019	-	Update to package V1.10
1.00	Nov 15, 2018	-	First release

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

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   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

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